



BRIGHT LED ELECTRONICS CORP.

LED LAMPS SPECIFICATION

TOTAL PAGE: 6
 PAGE: 1
 REVISION: 1.1



- COMMODITY : 2.0x5.0x9.6mm 1.0"Lead Rectangular LED LAMP
- DEVICE NUMBER : BL-R5132H

SHEET DATE	1	2	3	4	5	6					CONTENTS
2002.04.08	1.0	1.0	1.0	1.0	1.0	1.0					Initial Released
2002.07.03	1.1	1.1	-	-	-	1.1					Iv

TOTAL PAGE	6																			
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佰鴻工業股份有限公司

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LED LAMPS SPECIFICATION

PAGE: 2
VERSION : 1.1

- COMMODITY : 2.0x5.0x9.6mm 1.0"Lead Rectangular
- DEVICE NUMBER : BL-R5132H
- ELECTRICAL AND OPTICAL CHARACTERISTICS (Ta=25°C)

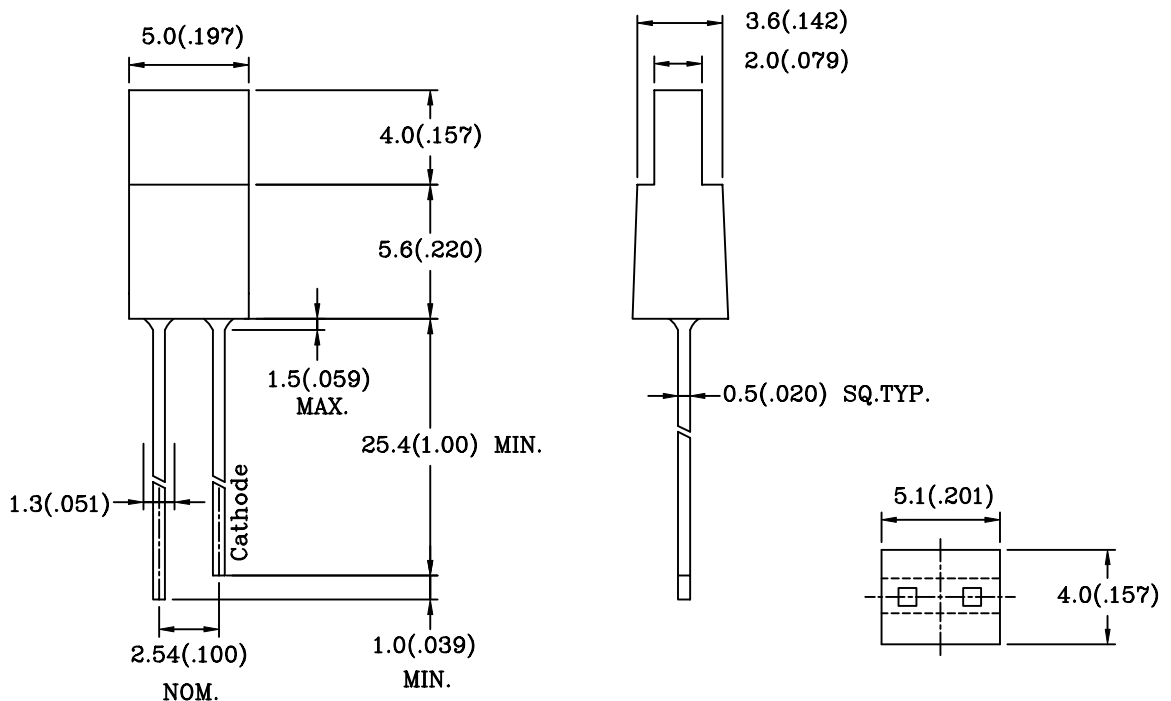
Chip		Lens Appearance	Absolute Maximum Rating				Electro-optical Data (At 20mA)			Viewing Angle 2θ 1/2 (deg)
Emitted Color	Peak Wave Length λ P(nm)		Δ λ (nm)	Pd (mW)	If (mA)	Peak If(mA)	Vf(V)		Iv Typ. (mcd)	
							Typ.	Max.		
Bright Red	700	Red Diffused	90	40	15	50	2.2	2.6	0.7	125

Remark : Viewing angle is the Off-axis angle at which the luminous intensity is half the axial luminous intensity.

● ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

Reverse Voltage	5V
Reverse Current (Vr=5V)	100μA
Operating Temperature Range	-40°C ~ 80°C
Storage Temperature Range	-40°C ~ 85°C
Lead Soldering Temperature	260°C For 5 Seconds

● PACKAGE DIMENSIONS



NOTES: 1.All dimensions are in millimeters (inches).

2.Tolerance is ± 0.25mm (0.01") unless otherwise specified.

3.Lead spacing is measured where the leads emerge from the package.

4.Specifications are subject to change without notice.

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● COMMODITY: 2.0x5.0x9.6mm 1.0" Lead Rectangular

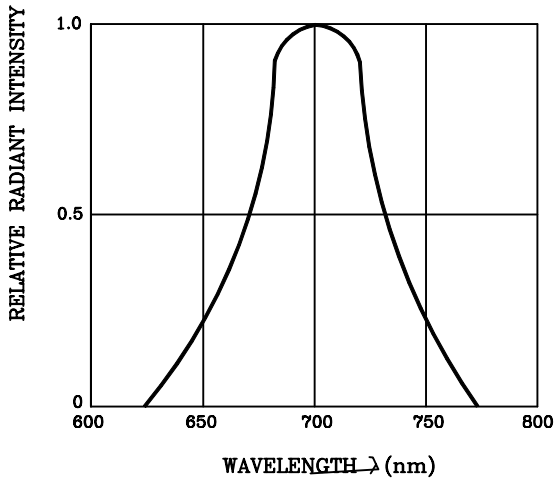
● DEVICE NUMBER: BL-R5132H

PAGE: 3-(2)

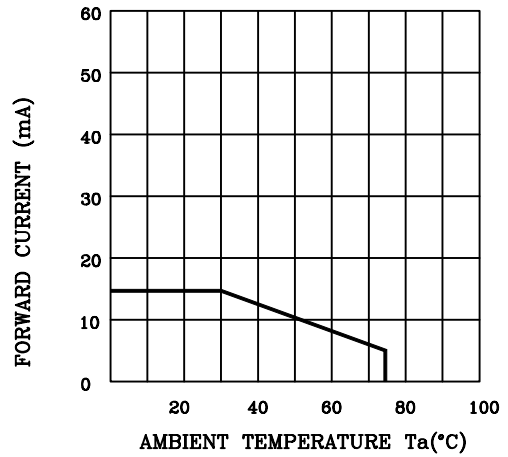
● ELECTRICAL AND OPTICAL CHARACTERISTICS(Ta=25°C)

REVISION: 1.0

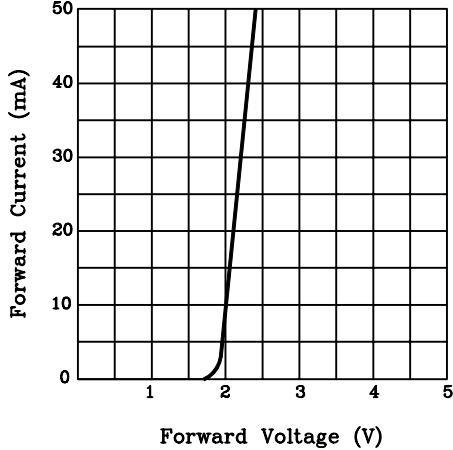
SPECTRAL DISTRIBUTION



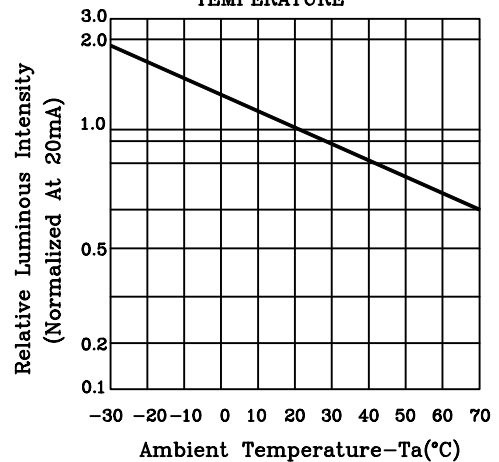
FORWARD CURRENT DERATING CURVE



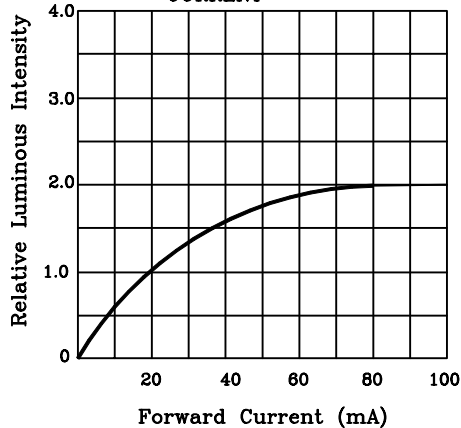
FORWARD CURRENT VS. FORWARD VOLTAGE



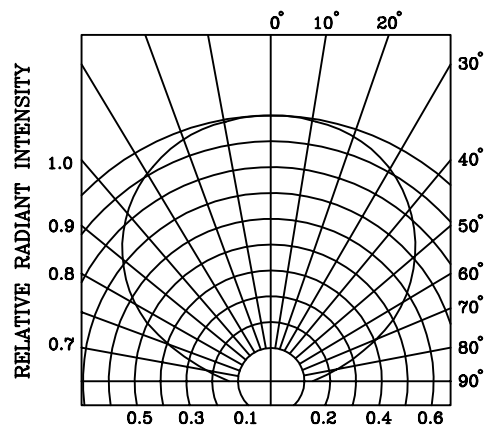
RELATIVE RADIANT INTENSITY VS. AMBIENT TEMPERATURE



RELATIVE RADIANT INTENSITY VS. FORWARD CURRENT



RADIATION DIAGRAM



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RELIABILITY TEST

PAGE: 4

REVISION: 1.0

Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance Test	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS C 7021 :B-1	Connect with a power $I_f=20\text{mA}$ T_a =Under room temperature Test time=1,000hrs	0/100
	High Temperature High Humidity Storage	MIL-STD-202:103B JIS C 7021 :B-11	$T_a=85^\circ\text{C}\pm 5^\circ\text{C}$ RH=90%-95% Test time=240hrs	0/100
	High Temperature Storage	MIL-STD-883:1008 JIS C 7021 :B-10	High $T_a=105^\circ\text{C}\pm 5^\circ\text{C}$ Test time=1,000hrs	0/100
	Low Temperature Storage	JIS-C-7021 :B-12	Low $T_a=-55^\circ\text{C}\pm 5^\circ\text{C}$ Test time=1,000hrs	0/100
Environmental Test	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS C 7021 :A-4	$-55^\circ\text{C} \sim 25^\circ\text{C} \sim 105^\circ\text{C} \sim 25^\circ\text{C}$ 30min 5min 30min 5min Test Time=10cycle	0/100
	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	$-55^\circ\text{C}\pm 5^\circ\text{C} \sim 105^\circ\text{C}\pm 5^\circ\text{C}$ 10min 10min Test Time=10cycle	0/100
	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS C 7021 :A-1	$T_{\text{sol}}=260\pm 5^\circ\text{C}$ Dwell Time= $5\pm 1\text{sec.}$	0/50
	Solder ability	MIL-STD-202:208D MIL-STD-750:2026 MIL-STD-883:2003 JIS C 7021 :A-2	$T_{\text{sol}}=230\pm 5^\circ\text{C}$ Dwell Time= $5\pm 1\text{sec.}$	0/50
	Lead Bending Stress	MIL-STD-750:2036 JIS C 7021 :A-11	$0^\circ\sim 90^\circ\sim 0^\circ\text{bend}$, 3 cycles Weight 250g	0/50

JUDGMENT CRITERIA OF FAILURE FOR THE RELIABILITY

Measuring items	Symbol	Measuring conditions	Judgement criteria for failure
Forward voltage	V_F	$I_f=20\text{mA}$	Over $U_x1.2$
Reverse current	I_r	$V_r=5\text{V}$	Over U_x2
Luminous intensity	I_v	$I_f=20\text{mA}$	Below $S_x0.5$

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

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PACKAGING DIMMENSIONS

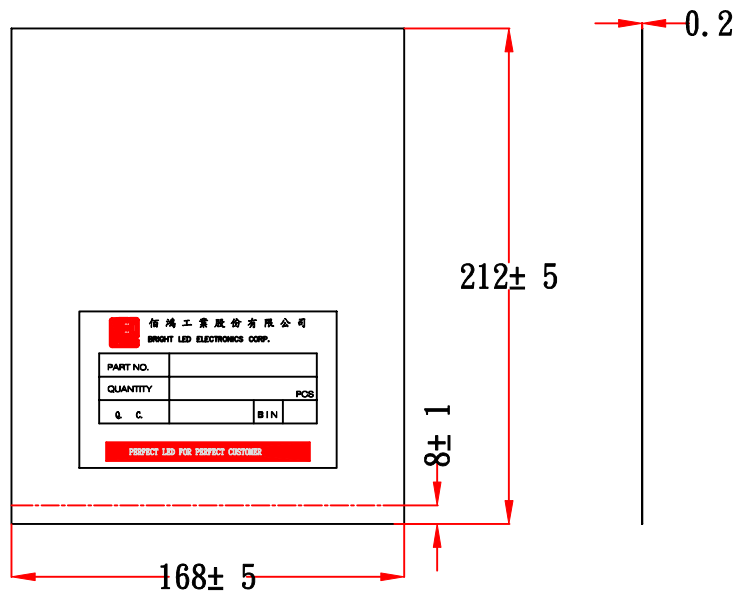
PAGE: 5

REVISION: 1.0

PACKAGING BOX DIMENSIONS



PACKAGING BAG DIMENSIONS



NOTES:

1. 500 PCS PER BAG, 5K PCS PER BOX
2. ALL Dimensions are in millimeters(inches).
3. Specifications are subject to change without notice.

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LED LAMPS SPECIFICATION Intensity And Color Bin Limits

● COMMODITY : 2.0x5.0x7.0mm 1.0"Lead , Rectangular

PAGE: 6

● DEVICE NUMBER : BL-R5132H

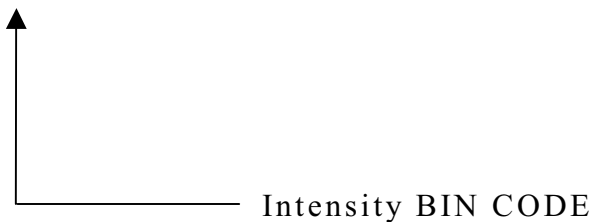
REVISION: 1.1

● Intensity Bin Limits (At 20mA)

BIN CODE	Min. (mcd)	Max. (mcd)
A	0.3	0.5
B	0.5	0.7
C	0.7	1.0
D	1.0	1.6

Tolerance for each Bin limit is $\pm 15\%$

● BIN : x



Notes:

1. Bin categories are established for classification of products.
Products may not be available in all bin categories.